

UNISONIC TECHNOLOGIES CO., LTD

MJE13003-H

NPN SILICON TRANSISTOR

NPN SILICON POWER TRANSISTOR

DESCRIPTION

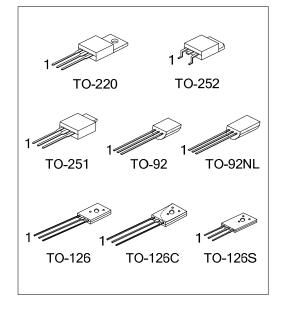
These devices are designed for high-voltage, high-speed power switching inductive circuits where fall time is critical. They are particularly suited for 115 and 220V applications in switch mode.

■ FEATURES

- * Reverse biased SOA with inductive load @ T_C=100°C
- * Inductive switching matrix $0.5 \sim 1.5$ Amp, 25 and 100° C Typical t_{C} = 290ns @ 1A, 100° C.
- * 900V blocking capability

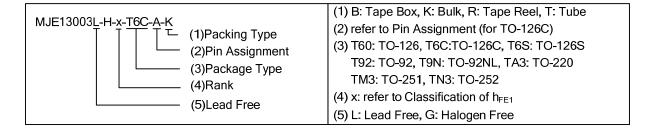
APPLICATIONS

- * Switching regulator's, inverters
- * Motor controls
- * Solenoid/relay drivers
- * Deflection circuits



ORDERING INFORMATION

Ordering	Dookogo	Pin Assignment			Dooking		
Lead Free	Halogen-Free	Package	1	1 2 3		Packing	
MJE13003L-H-x-T60-K	MJE13003G-H-x-T60-K	TO-126	В	С	E	Bulk	
MJE13003L-H-x-T6C-A-K	MJE13003G-Hx-T6C-A-K	TO-126C	Е	С	В	Bulk	
MJE13003L-H-x-T6C-K	MJE13003G-H-x-T6C-K	TO-126C	В	С	Е	Bulk	
MJE13003L-H-x-T6S-K	MJE13003G-H-x-T6S-K	TO-126S	В	С	Е	Bulk	
MJE13003L-H-x-T92-B	MJE13003G-H-x-T92-B	TO-92	Е	С	В	Tape Box	
MJE13003L-H-x-T92-K	MJE13003G-H-x-T92-K	TO-92	Е	С	В	Bulk	
MJE13003L-H-x-T92-R	MJE13003G-H-x-T92-R	TO-92	Е	С	В	Tape Reel	
MJE13003L-H-x-T9N-B	MJE13003G-H-x-T9N-B	TO-92NL	Е	С	В	Tape Box	
MJE13003L-H-x-T9N-K	MJE13003G-H-x- T9N-K	TO-92NL	Е	С	В	Bulk	
MJE13003L-H-x- T9N-R	MJE13003G-H-x- T9N-R	TO-92NL	Е	С	В	Tape Reel	
MJE13003L-H-x-TA3-T	MJE13003G-H-x-TA3-T	TO-220	В	С	E	Tube	
MJE13003L-H-x-TM3-T	MJE13003G-H-x-TM3-T	TO-251	В	С	Ε	Tube	
MJE13003L-H-x-TN3-R	MJE13003G-H-x-TN3-R	TO-252	В	С	E	Tape Reel	
MJE13003L-H-x-TN3-T	MJE13003G-H-x-TN3-T	TO-252	В	С	E	Tube	



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■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT	
Collector-Emitter Voltage		$V_{CEO(SUS)}$	400	V	
Collector-Base Voltage		V_{CBO}	900	V	
Emitter Base Voltage	ge		V_{EBO}	9	V
Continuous		Ic	1.5	^	
Collector Current		Peak (1)	I _{CM}	3	A
Dana Ourrant		Continuous	Ι _Β	0.75	
Base Current		Peak (1)	I _{BM}	1.5	A
Emitter Current		Continuous	Ι _Ε	2.25	
		Peak (1)	I _{EM}	4.5	A
Power Dissipation	T _A =25°C	TO-126 / TO-126C		1.4	W
		TO-126S		1.4	VV
		TO-92 / TO-92NL		1.1	W
		TO-220		2	W
		TO-251 / TO-252	В	1.56	W
	T _C =25°C	TO-126 / TO-126C	P_D	20	W
		TO-126S		20	VV
		TO-92 / TO-92NL		1.5	W
		TO-220		40	W
		TO-251 / TO-252		25	W
Junction Temperature		T _J	+150	°C	
Storage Temperature		T _{STG}	-55 ~ + 150	°C	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ **ELECTRICAL CHARACTERISTICS** (T_C=25°C, unless otherwise specified.)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS (Note)									
Collector-Emitter Sustaining Voltage		V _{CEO(SUS)}	I _C =10mA , I _B =0	400			V		
	T _C =25°C		V _{CEO} =Rated Value,			1			
Collector Cutoff Current	T _C =100°C	I _{CEO}	V _{BE(OFF)} =1.5 V			5	mA		
Emitter Cutoff Current		I _{EBO}	V _{EB} =9V, I _C =0	1	mA				
SECOND BREAKDOWN									
Second Breakdown Collector Current forward biased	with bass	ls/b		See Fig.5					
Clamped Inductive SOA with base rev	erse biased	RB _{SOA}			See Fig.6				
ON CHARACTERISTICS (Note)	0.00 0.000	112307			<u> </u>				
,		h _{FE1}	I _C =0.3A, V _{CE} =5V	14		57			
DC Current Gain		h _{FE2}	I _C =1A, V _{CE} =5V	5		30			
		1	I _C =0.5A, I _B =0.1A			0.5	+		
		V _{CE(SAT)}	I _C =1A, I _B =0.25A			1			
Collector-Emitter Saturation Voltage	Collector-Emitter Saturation Voltage		I _C =1.5A, I _B =0.5A			3	- V		
			I _C =1A, I _B =0.25A, T _C =100°C			1			
			I _C =0.5A, I _B =0.1A			1			
Base-Emitter Saturation Voltage		$V_{BE(SAT)}$	I _C =1A, I _B =0.25A			1.2	l v l		
		52(6/11)	I _C =1A, I _B =0.25A, T _C =100°C			1.1	1		
DYNAMIC CHARACTERISTICS						•			
Current-Gain-Bandwidth Product		f⊤	I _C =100mA, V _{CE} =10V, f=1MHz	4	10		MHz		
Output Capacitance		Сов	V _{CB} =10V, I _E =0, f=0.1MHz		21		pF		
SWITCHING CHARACTERISTICS									
Resistive Load (Table 1)					-				
Delay Time Rise Time Storage Time Fall Time		t_D			0.05	0.1	μs		
		t_R	V _{CC} =125V, I _C =1A, _{B1} =I _{B2} =0.2A,		0.5	1	μs		
		ts	t _P =25µs, Duty Cycle≤1%		2	4	μs		
		t_{\scriptscriptstyleF}			0.4	0.7	μs		
Inductive Load, Clamped (Table 1)									
Storage Time		t _{STG}	-1 -14 \/ -300\/ 1 -0.34		1.7	4	μs		
Crossover Time		t_{C}	I _C =1A, V _{CLAMP} =300V, I _{B1} =0.2A, V _{BE(OFF)} =5V _{DC} , T _C =100°C		0.29	0.75	μs		
Fall Time		$t_{\scriptscriptstyle{F}}$	VBE(OFF)=3 VDC, 1C=100 C		0.15		μs		

Note: Pulse Test: PW=300µs, Duty Cycle≤2%

■ CLASSIFICATION OF h_{FE1}

RANK	Α	В	С	D	E	F	G	Н
RANGE	14 ~ 22	21 ~ 27	26 ~ 32	31 ~ 37	36 ~ 42	41 ~ 47	46 ~ 52	51 ~ 57

APPLICATION INFORMATION

Table 1.Test Conditions for Dynamic Performance

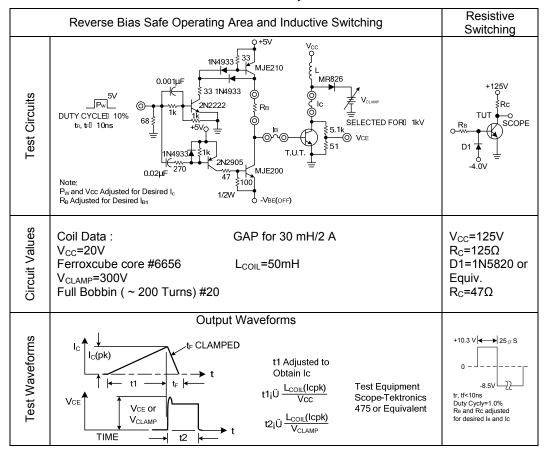


Table 2. Typical Inductive Switching Performance

Ic	Tc	t _{sv}	t _{RV}	t _{FI}	t _{TI} (µs)	tc
(A)	(°C)	(µs)	(µs)	(µs)		(µs)
0.5	25	1.3	0.23	0.30	0.35	0.30
	100	1.6	0.26	0.30	0.40	0.36
1	25	1.5	0.10	0.14	0.05	0.16
	100	1.7	0.13	0.26	0.06	0.29
1.5	25	1.8	0.07	0.10	0.05	0.16
	100	3	0.08	0.22	0.08	0.28

Note: All Data Recorded in the Inductive Switching Circuit in Table 1

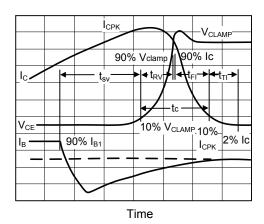


Fig.1 Inductive Switching Measurements

■ SWITCHING TIMES NOTE

In resistive switching circuits, rise, fall, and storage times have been defined and apply to both current and voltage waveforms since they are in phase. However, for inductive loads, which are common to switch mode power supplies and hammer drivers, current and voltage waveforms are not in phase. Therefore, separate measurements must be made on each waveform to determine the total switching time. For this reason, the following new terms have been defined.

 t_{SV} = Voltage Storage Time, 90% I_{B1} to 10% V_{CLAMP}

 t_{RV} = Voltage Rise Time, 10 ~ 90% V_{CLAMP}

 t_{FI} = Current Fall Time, 90 ~ 10% I_{C}

 t_{TI} = Current Tail, 10 ~ 2% I_{C}

 t_C = Crossover Time, 10% V_{CLAMP} to 10% I_C

For the designer, there is minimal switching loss during storage time and the predominant switching power losses occur during the crossover interval and can be obtained using the standard equation:

$$P_{SWT} = 1/2 V_{CC}I_{C} (t_{C}) f$$

In general, $t_{RV} + t_{FI} \approx t_C$. However, at lower test currents this relationship may not be valid.

As is common with most switching transistors, resistive switching is specified at 25°C and has become a benchmark for designers. However, for designers of high frequency converter circuits, the user oriented specifications which make this transistor are the inductive switching speeds (t_C and t_{SV}) which are guaranteed at $100^{\circ}C$.

RESISTIVE SWITCHING PERFORMANCE

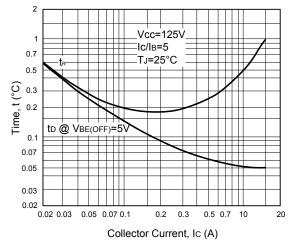


Fig.2 Turn-On Time

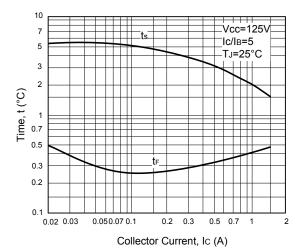


Fig.3 Turn-Off Time

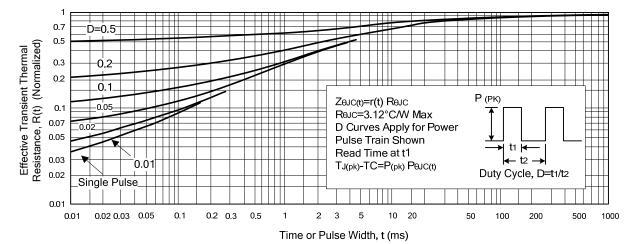


Fig.4 Thermal Response

SAFE OPERATING AREA INFORMATION

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C - V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

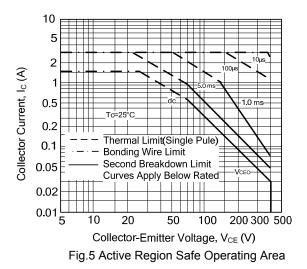
The data of Fig.5 is based on $T_C = 25^{\circ}C$; $T_{J(PK)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \ge 25^{\circ}C$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Fig.5.

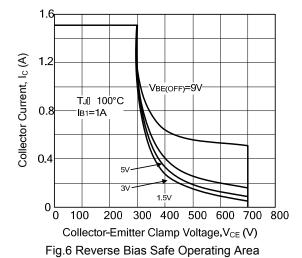
 $T_{J(PK)}$ may be calculated from the data in Fig.4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

REVERSE BIAS

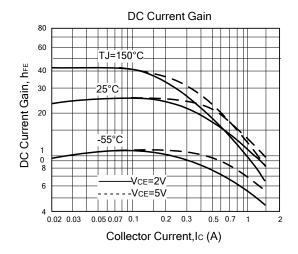
For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as RB_{SOA}(Reverse Bias Safe Operating Area) and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Fig.6 gives RB_{SOA} characteristics.

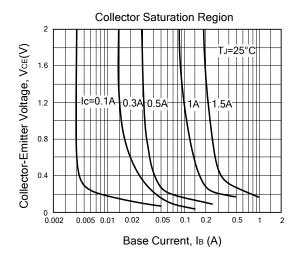
The Safe Operating Area of Fig.5 and 6 are specified ratings (for these devices under the test conditions shown.)

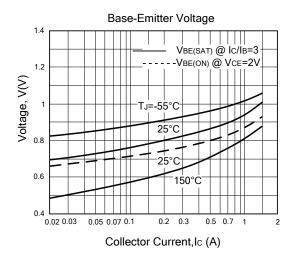


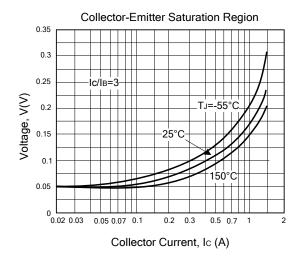


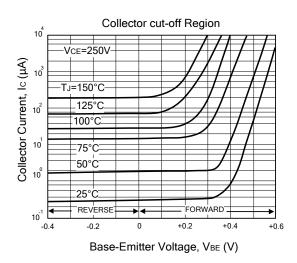
■ TYPICAL CHARACTERISTICS

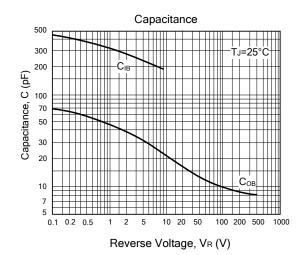




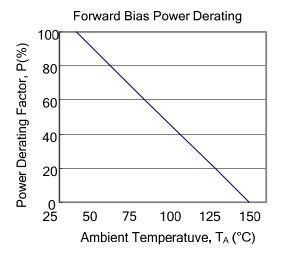








■ TYPICAL CHARACTERISTICS(Cont.)



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